

June 2011

# FAB2200 Audio Subsystem with Stereo Class-G Headphone Amplifier and 1.2W Mono Class-D Speaker Amplifier

#### Features

- Single Supply: 2.8V 5.25V
- Pop and Click Suppression
- Differential or Single-Ended Audio Inputs
- Rejects TDMA Noise from GSM Handsets
- Filterless Fully Differential Class-D Speaker Amplifier
  - Programmable Edge-Rate Control and Spread Spectrum Minimize EMI
  - 1.2W into 8Ω at 4.2V, THD+N < 10%
  - 970mW into 8 $\Omega$  at 4.2V, THD+N < 1%
  - 90% Efficiency
  - Automatic Gain Control Limits Distortion and Protects Speakers at All Battery Voltages
  - Noise Gate Improves Audio Quality
- Headphone Amplifier
  - Power-Saving Class-G Operation
  - Audio Taper I<sup>2</sup>C Volume Control
  - Capacitor-Free Outputs
  - Integrated Regulated Charge Pump
  - SGND Pin Eliminates Ground-Loop Noise
  - Noise Gate Improves Audio Quality
- DPST Analog Bypass Switch
- I<sup>2</sup>C Control
- Low-Power Shutdown Mode
- Current Limit and Thermal Protection
- 25-Bump, 0.4mm Pitch WLCSP Package

# Description

The FAB2200 combines a capacitor-free stereo headphone amplifier with a monolithic class-D speaker amplifier.

An integrated charge pump generates multiple supply rails for a ground-centered class-G headphone output. The charge pump is regulated for high Power Supply Rejection Ratio (PSRR).

The filterless class-D amplifier can be connected directly to a speaker without external filters.

The programmable Automatic Gain Control (AGC) limits maximum speaker output levels to protect speakers without introducing distortion. It can also dynamically limit clipping as the battery voltage falls.

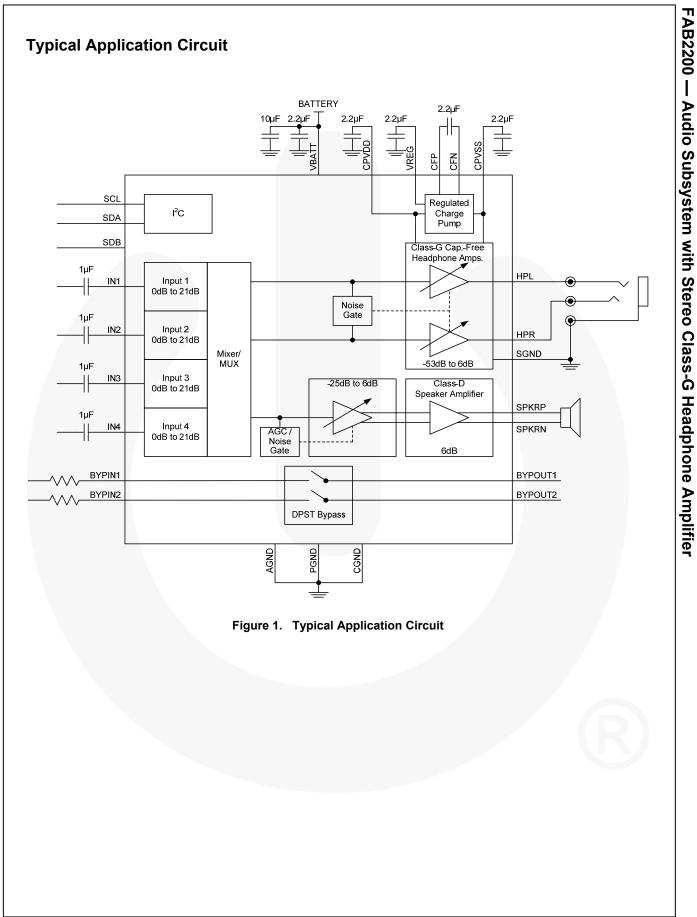
The noise gate can automatically mute the speaker or headphone amplifiers to reduce noise when input signals are low.

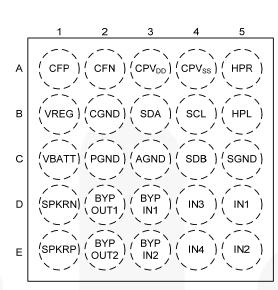
## Applications

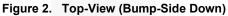
- Cellular Handsets
- Notebook Computers
- Tablet PCs

Ordering	Information
----------	-------------

Part Number	Operating Temperature Range	rating Temperature Range Package	
FAB2200UCX	$-40 \text{ to } +85^{\circ}\text{C}$	25-Bump, 0.4mm Pitch, Wafer-Level Chip-Scale Package (WLCSP)	3000 Units on Tape & Reel







# **Pin Definitions**

**Pin Configuration** 

WLCSP	Name	Description	Туре
C1	VBATT	Power supply for speaker amplifier	Power
B2	PGND	Charge pump ground	Power
C2	PGND	Power ground	Power
C3	AGND	Analog ground	Power
B1	VREG	Charge pump regulator – do not connect to an external power supply	Power
A3		Charge pump output – positive power supply for headphone amplifier	Power
A4	CPV <sub>SS</sub>	Charge pump output – negative mirror of CPV <sub>DD</sub>	Power
A1	CFP	Charge pump flying capacitor positive terminal	Power
A2	CFN	Charge pump flying capacitor negative terminal	Power
D5	IN1	Line level audio input	Input
E5	IN2	Line level audio input	Input
D4	IN3	Line level audio input	Input
E4	IN4	Line level audio input	Input
B5	HPL	Left headphone output	Output
A5	HPR	Right headphone output	Output
C5	SGND	Sense ground – connect to AGND close to shield terminal of headphone jack	Input
E1	SPKRP	Positive speaker output	Output
D1	SPKRN	Negative speaker output	Output
D3	BYPIN1	Analog bypass switch input	Input
E3	BYPIN2	Analog bypass switch input	Input
D2	BYPOUT1	Analog bypass switch output	Output
E2	BYPOUT2	Analog bypass switch output	Output
C4	SDB	Shutdown control	Input
B4	SCL	I <sup>2</sup> C clock input	Input
B3	SDA	I <sup>2</sup> C data I/O	Bi-direction

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The Absolute Maximum Ratings are stress ratings only. All voltages are referenced to GND.

Symbol	Parameter	Min.	Max.	Unit
VBATT	Voltage on VBATT Pin	-0.3	6.0	V
V <sub>IN</sub>	Voltage on IN1, IN2, IN3, IN4, HPL, HPR Pins	CPV <sub>SS</sub> -0.3	CPV <sub>DD</sub> +0.3	V
V <sub>SGND</sub>	Voltage on SGND Pin	-0.3	0.3	V
Vs	Voltage on SDA, SCL, SDB Pins	-0.3	V <sub>BATT</sub> +0.3	V
V <sub>SP</sub>	Voltage on SPKRP, SPKRN Pins	-0.3	V <sub>BATT</sub> +0.3	V
V <sub>BYP</sub>	Voltage on BYPIN1, BYPIN2, BYPOUT1, BYPOUT2 Pins	-0.3	V <sub>BATT</sub> +0.3	V
	Duration of SPKRP, SPKRN Short Circuit to GND or VBATT		Continuous	
	Duration of Short Circuit Between SPKRP and SPKRN		Continuous	
	Duration of HPL, HPR Short Circuit to GND		Continuous	

# **Reliability Information**

Symbol	Parameter	Min.	Тур.	Max.	Unit
TJ	Junction Temperature			+150	°C
T <sub>STG</sub>	Storage Temperature Range	-65		+150	°C
TL	Peak Reflow Temperature			+300	°C
$\theta_{JA}$	Thermal Resistance, JEDEC Standard, Multilayer Test Boards, Still Air		60		°C/W
TSD	Thermal Shutdown Threshold		+150		°C
T <sub>HYS</sub>	Thermal Shutdown Hysteresis		+35		°C

# **ESD** Protection

Symbol	Parameter	Condition	Min.	Unit
НВМ	HBM Human Body Model (HBM) HBM HUMAN HIGH HIGH HIGH HIGH HIGH HIGH HIGH HIG		3	kV
CDM	M Charged Device Model (CDM) JESD22-C101-C Level III, IEC61340-3-3 Level C4, ESD-STM5.3.1-1999 Level C4		2	kV

#### Notes:

1. Device-use-level ESD tests are conducted at the connector pins.

 External ESD suppressor ASIP protects the amplifier outputs. Suppressor is between amplifier and connector; 15Ω serial resistance + 5nF capacitor and Zener diodes (14V breakdown voltage) connected to the ground. In addition, there is a ferrite bead in series between the suppressor and the connector.

3. The air discharge test can be ignored if the contact discharge test range is increased to the same voltages as air discharge (contact discharge is more stable and repeatable test than air discharge).

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	····		Max.	Unit
T <sub>A</sub>	Operating Temperature Range	-40	+85	°C
V <sub>BATT</sub>	Supply Voltage Range	2.80	5.25	V

# **Electrical Characteristics**

Unless otherwise noted: HPA uses stereo single-ended inputs, SPA uses differential input, unused inputs AC are grounded,  $f_{IN}$  = 1KHz, AGC off, PGAINxx = 0dB, HPxVOL = 0dB, PRESENTGAIN = 6dB, ERC = 1, SSMT = 000, SHDNB = 1, SDB = 1.8V, SDA and SCL pull-up voltage = 1.8V,  $Z_{SPK}$  = 8 $\Omega$ +68 $\mu$ H,  $R_{HP}$  = 32 $\Omega$ , speaker amplifier and headphone amplifier on. Typical values are at  $V_{BATT}$  = 3.7V,  $T_A$  = 25°C. Minimum and maximum values are at  $V_{BATT}$  = 2.8V to 5.25V,  $T_A$  = -40°C to 85°C.

Symbol	Parameter	Conditio	ons	Min.	Тур.	Max.	Unit	
		Headphone Amplifiers Speaker Amplifier Dis DIFFIN43=1			3.5			
I <sub>DD</sub>	Quiescent Supply Current (Z <sub>SPK</sub> = Open)	Headphone Amplifiers Speaker Amplifier En DIFFIN21=1			4.7		mA	
		Headphone and Spea Enabled	aker Amplifiers		6.2			
	Obutdaum Ourrant	SHDNB = 0, SDB = 1	.8V		2.2			
I <sub>SD</sub>	Shutdown Current	SHDNB = 1, SDB = G	ND		2.2		μA	
t <sub>on</sub>	Turn-On Time	Time from Shutdown and Headphone Oper Ramps Disabled			1.25		ms	
Р	Input Desistance	PGAINxx = 0dB			21.0		ΚΩ	
R <sub>IN</sub>	Input Resistance	PGAINxx = 12dB			8.5		N12	
	Maximum Input Signal Swing	PGAINxx = 0dB PGAINxx = 12dB		/	2.300			
	(V <sub>BATT</sub> = 2.8V to 5.25V, Single-Ended Input)				0.575		V <sub>pk-pk</sub>	
Analog By	pass Switch							
R <sub>on</sub>	On Resistance	$I_{BYPOUTx} = 20mA,$ BYPx = 0V and V <sub>BATT</sub> , BYPEN = 1	T <sub>A</sub> = 25°C			1	Ω	
THD	Total Harmonic Distortion	V <sub>DIF</sub> = 2V <sub>PP</sub> , V <sub>CM</sub> = V <sub>BATT</sub> /2, f = 1kHz, BYPEN = 1,	Series Resistance is 10Ω per Switch		0.05	0.25	%	
		Load = 8Ω	No Series Resistors		0.10			
I <sub>OFF</sub>	Off Isolation	BYPEN = 0, 10KHz $1V_{RMS}$ Sine Wave Applied Across BYPOUT1 and BYPOUT2, BYPIN1 and BYPIN2 to GND = $50\Omega$			94		dB	

Continued on the following page...

www.fairchildsemi.com

# Electrical Characteristics (Continued)

Unless otherwise noted: HPA uses stereo single-ended inputs, SPA uses differential input, unused inputs AC are grounded,  $f_{IN}$  = 1KHz, AGC off, PGAINxx = 0dB, HPxVOL = 0dB, PRESENTGAIN = 6dB, ERC = 1, SSMT = 000, SHDNB = 1, SDB = 1.8V, SDA and SCL pull-up voltage = 1.8V,  $Z_{SPK}$  = 8 $\Omega$ +68µH,  $R_{HP}$  = 32 $\Omega$ , speaker amplifier and headphone amplifier on. Typical values are at  $V_{BATT}$  = 3.7V,  $T_A$  = 25°C. Minimum and maximum values are at  $V_{BATT}$  = 2.80V to 5.25V,  $T_A$  = -40°C to 85°C.

Symbol	Parameter	Conditio	ons	Min.	Тур.	Max.	Unit
Speaker A	mplifier						
.,		PRESENTGAIN = Mute			±0.5		
Vos	Output Offset Voltage	PRESENTGAIN = 6dB			±2.5		mV
		Peak Voltage,	Into Shutdown		-70		
K <sub>CP</sub>	Click-and-Pop Level	A-Weighted, 32 Samples per Second, PRESENTGAIN = Mute, Inputs AC Grounded	Out of Shutdown		-70		dB∨
			V <sub>BATT</sub> = 2.8V to 5.25V		74		
PSRR	Power-Supply Rejection Ratio	Inputs AC Grounded	f = 217Hz, 100mV <sub>PP</sub> Ripple		77		dB
			f = 1kHz, 100mV <sub>PP</sub> Ripple		75		
		THD+N < 1%, ERC Disat V <sub>BATT</sub> = 4.2V	oled, SSMT = 100,		970		
		THD+N < 10%, ERC Disa 100, V <sub>BATT</sub> = 4.2V	abled, SSMT =		1200		
Pout	Output Power THD+N < 10%, ERC I SSMT = 100, V <sub>BATT</sub> =				930		mW
		THD+N < 10%, ERC Enabled, SSMT = 000, $V_{\text{BATT}}$ = 3.7V			945		
		THD+N < 1%, ERC	V <sub>BATT</sub> = 4.2V	930	975		
		Enabled, SSMT = 000	V <sub>BATT</sub> = 3.7V		750		
THD+N	Total Harmonic Distortion Plus Noise	P <sub>OUT</sub> = 350mW			0.030	0.075	%
		A-Weighted, P <sub>OUT</sub> = 720mW, Headphone	DIFFINxx = 0 (Single-Ended)		97	/	
SNR	Signal-to-Noise Ratio	Amplifiers Off	DIFFINxx = 1 (Differential)	90	97		dB
GINIX	Signal-lo-rolise ralio	A-Weighted, P <sub>OUT</sub> = 720mW, Headphone	DIFFINxx = 0 (Single-Ended)		97		
		Amplifiers On	DIFFINxx = 1 (Differential)		97	6	
Vn	Output Noise	A-Weighted, Headphone Amps Off, DIFFINxx = 0, Inputs AC Grounded			32		μV <sub>RM</sub>
	Output Frequency	Spread Spectrum, SSMT	= 000		330		KHz
		Fixed Frequency, SSMT	= 100		330		13112
I <sub>OUT</sub>	Output Current Limit				1.3		Α
	Efficiency	$P_{OUT}$ = 720mW, f = 1kHz			90		%
	Mute Attenuation				100		dB

## Electrical Characteristics (Continued)

Unless otherwise noted: HPA uses stereo single-ended inputs, SPA uses differential input, unused inputs AC are grounded,  $f_{IN}$  = 1KHz, AGC off, PGAINxx = 0dB, HPxVOL = 0dB, PRESENTGAIN = 6dB, ERC = 1, SSMT = 000, SHDNB = 1, SDB = 1.8V, SDA and SCL pull-up voltage = 1.8V,  $Z_{SPK}$  =  $8\Omega$ +68µH,  $R_{HP}$  =  $32\Omega$ , speaker amplifier and headphone amplifier on. Typical values are at  $V_{BATT}$  = 3.7V,  $T_A$  =  $25^{\circ}$ C. Minimum and maximum values are at  $V_{BATT}$  = 2.80V to 5.25V,  $T_A$  =  $-40^{\circ}$ C to  $85^{\circ}$ C.

Symbol	Parameter	Conditions	5	Min.	Тур.	Max.	Unit
Headpho	ne Amplifiers						
			$P_{OUT} = 2x50\mu W$ into $32\Omega$		4.4		
$I_{VBATT}$	Supply Current	IN1 and IN2 On, IN3 and IN4 Off, DIFFIN43=1, Speaker Amplifier Off	$P_{OUT} = 2x250\mu W$ into $32\Omega$		5.8		mA
			$P_{OUT} = 2x500 \mu W$ into $32\Omega$		6.8		
Vos	Output Offset Voltage	HPxVOL = Mute			±0.15		mV
K <sub>CP</sub>	Click-and-Pop Level	Peak Voltage, A-Weighted, 32 Samples per Second, HPxVOL = Mute,	Into Shutdown		-70		dBV
		Inputs AC Grounded	Out of Shutdown		-70		
	V <sub>BATT</sub> = 2.8V to 5.25V		95				
PSRR	Power-Supply Rejection Ratio	Inputs AC Grounded	f = 217Hz, V <sub>RIPPLE</sub> = 200mV <sub>PP</sub>		95		dB
			$f = 1KHz, V_{RIPPLE}$ = 200mV <sub>PP</sub>		95		
		THD+N < 1%	R <sub>HP</sub> = 16Ω		39		
Pout	Output Power		$R_{HP} = 32\Omega$ HPxV <sub>OL</sub> = 4dB	27	31		mW
		THD+N < 10%	$R_{HP} = 32\Omega$ HPxV <sub>OL</sub> = 6dB		41		
THD+N	Total Harmonic	$R_{HP}$ = 32 $\Omega$ , $P_{OUT}$ = 20mW			0.010	0.075	%
	Distortion Plus Noise	$R_{HP}$ = 16 $\Omega$ , $P_{OUT}$ = 10mW			0.020		70
		A-Weighted, P <sub>OUT</sub> = 32mW, Speaker Amplifier Off	DIFFINxx = 0 (Single-Ended)	95	100		
SNR	Signal-to-Noise Ratio	HPxVOL = 4dB	DIFFINxx = 1 (Differential)		100		dB
Unit .		A-Weighted, P <sub>OUT</sub> = 32mW, Speaker Amplifier On	DIFFINxx = 0 (Single-Ended)		100		u.D
		HPxVOL = 4dB	DIFFINxx = 1 (Differential)		103		
	Output Noise	A-Weighted, Speaker Amplifier	Off, DIFFINxx = 0		6.5		μV <sub>RM</sub>
CL	Capacitive Drive				100		pF
X <sub>TALK</sub>	Crosstalk	HPL to HPR, HPR to HPL, Po	= 15mvv		-85		dB
f <sub>P</sub>	Charge-Pump Frequency				1.3		MHz
Av	Headphone Gain Accuracy	Across All Gain Stages			±0.4		dB
	Channel-to-Channel Gain Tracking	HPL to HPR, HPxVOL = 0dB			±0.3		%
	Channel-to-Channel Gain Tracking	HPL to HPR Across Entire Pre Volume Range	-Amplifier and		±1		%
	Mute Attenuation				100		dB

# I<sup>2</sup>C DC Electrical Characteristics

Unless otherwise noted,  $V_{BATT}$  = 2.80V to 5.25V and  $T_A$  = -40°C to 85°C.

Symbol	Deremeter	Conditions	Fast Mode (400kHz)		
	Parameter	Conditions	Min.	Max.	Unit
VIL	Low-Level Input Voltage	V <sub>BATT</sub> 2.80V to 5.25V	-0.3	0.6	V
V <sub>IH</sub>	High-Level Input Voltage	V <sub>BATT</sub> 2.80V to 5.25V	1.3		V
V <sub>OL</sub>	Low-level Output Voltage	at 3mA Sink Current (Open-Drain or Open-Collector)	0	0.4	V
I <sub>IH</sub>	High-Level Input Current	Each I/O Pin, Input Voltage = V <sub>BATT</sub>	-1	1	μA
IIL	Low-Level Input Current	Each I/O Pin, Input Voltage = 0V	-1	1	μA

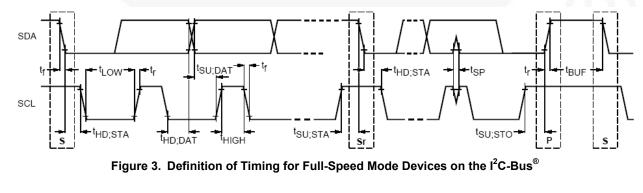
# I<sup>2</sup>C AC Electrical Characteristics

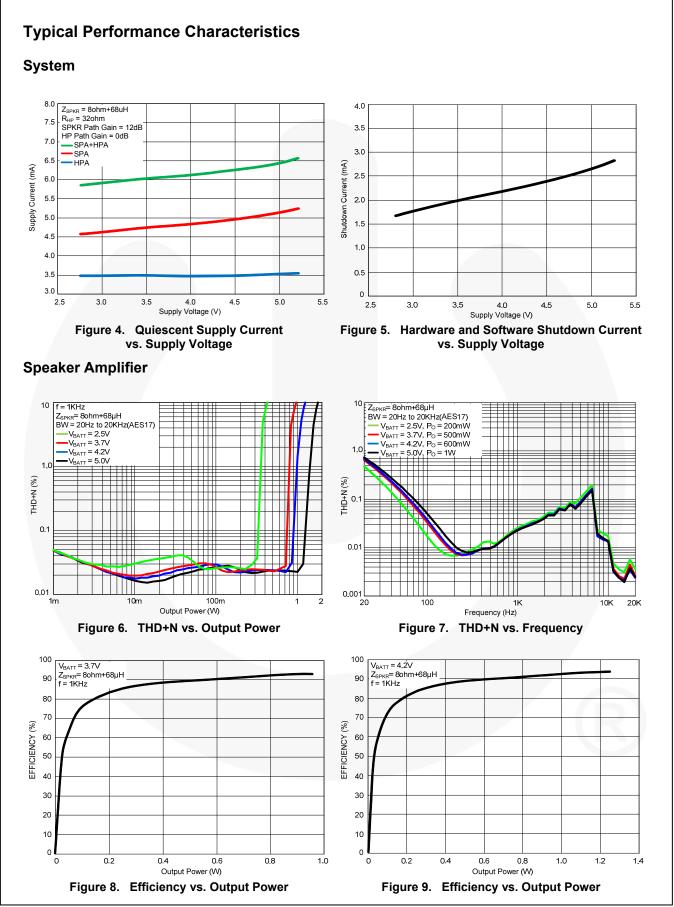
Unless otherwise noted,  $V_{BATT}$  = 2.80V to 5.25V and  $T_A$  = -40°C to 85°C.

Ourseland	Demonster	Fa	Fast Mode			
Symbol	Parameter	Min.	Max.	Unit		
f <sub>SCL</sub>	SCL Clock Frequency	0	400	kHz		
t <sub>HD;STA</sub>	Hold Time (Repeated) START Condition	0.6		μs		
t <sub>LOW</sub>	LOW Period of SCL Clock	1.3		μs		
t <sub>HIGH</sub>	HIGH Period of SCL Clock	0.6		μs		
t <sub>su;sta</sub>	Set-up Time for Repeated START Condition	0.6		μs		
$t_{HD;DAT}$	Data Hold Time	0	0.9	μs		
t <sub>su;dat</sub>	Data Set-up Time <sup>(4)</sup>	100		ns		
t <sub>r</sub>	Rise Time of SDA and SCL Signals <sup>(5)</sup>	20+0.1Cb	300	ns		
t <sub>f</sub>	Fall Time of SDA and SCL Signals <sup>(5)</sup>	20+0.1Cb	300	ns		
t <sub>su;sто</sub>	Set-up Time for STOP Condition	0.6		μs		
t <sub>BUF</sub>	Bus Free Time between STOP and START Conditions	1.3		μs		
t <sub>SP</sub>	Pulse Width of Spikes that Must Be Suppressed by the Input Filter	0	50	ns		

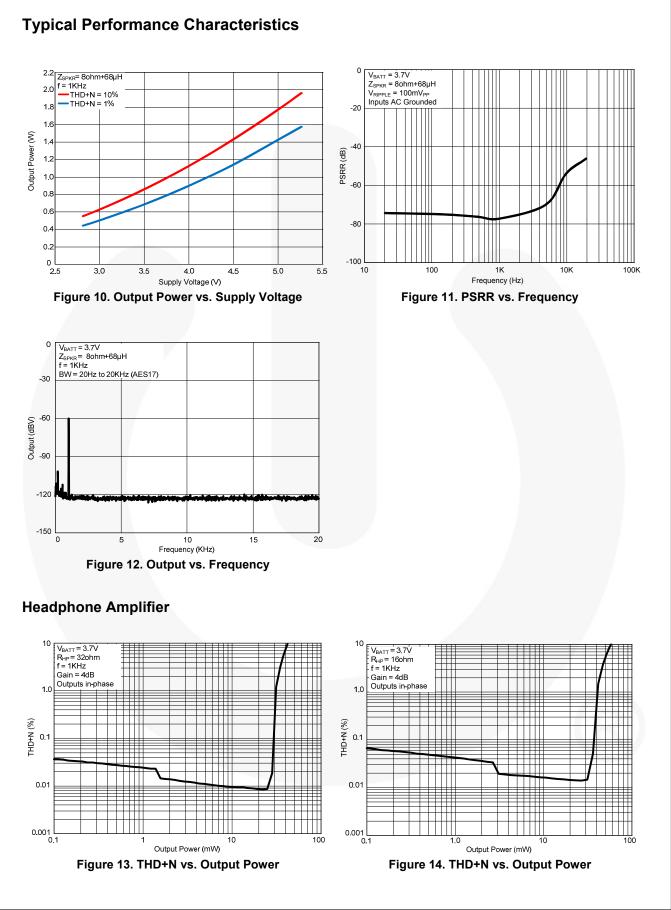
Notes:

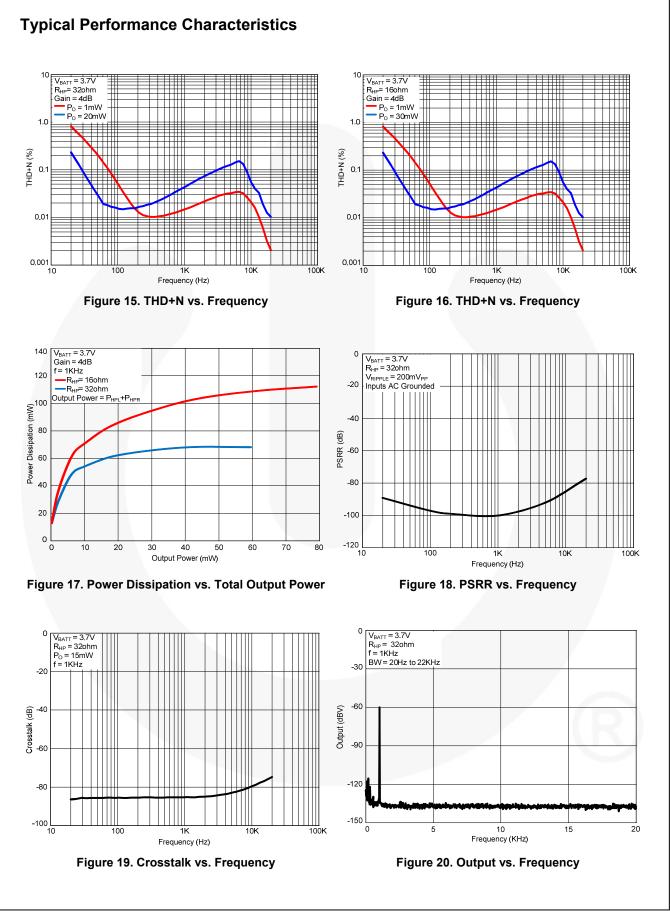
- 4. A fast-mode I<sup>2</sup>C-Bus<sup>®</sup> device can be used in a standard-mode system, but the requirement t<sub>SU;DAT</sub> ≥ 250ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t<sub>r\_max</sub> + t<sub>SU;DAT</sub> = 1000 + 250 = 1250ns (according to the standard-mode I<sup>2</sup>C bus specification) before the SCL line is released.
- C<sub>b</sub> equals the total capacitance of one bus line in pf. If mixed with high-speed mode devices, faster fall times are allowed according to the I<sup>2</sup>C specification.





FAB2200 — Audio Subsystem with Stereo Class-G Headphone Amplifier





# **Functional Description**

#### Shutdown Mode

When SHDNB bit is set to 0 or the SDB pin is grounded, the FAB2200 enters low-power Shutdown Mode.

While SHDNB=0 and SDB is HIGH, I<sup>2</sup>C communication is available. I<sup>2</sup>C values are preserved. Values are not reset on exiting Shutdown Mode.

If the SDB pin is grounded,  $I^2C$  communication is unavailable.  $I^2C$  values are not preserved. Values are reset to default values after SDB goes HIGH.

#### Inputs During Shutdown

To achieve low supply current during shutdown, all inputs must be at DC levels (except the BYPASS pins). Audio inputs must be AC grounded.  $V_{BATT}$  must be within recommended operating conditions. I<sup>2</sup>C pins must be grounded or pulled HIGH with no toggling. If AC is presented to the inputs during shutdown, standby current may increase slightly, but there are no other negative effects.

#### **Thermal Shutdown**

If the junction temperature of the device exceeds the thermal shutdown threshold (see *Electrical Characteristics table*), the device protects itself by shutting down. The device remains shut down until the junction temperature falls below the thermal shutdown hysteresis.

The  $I^2C$  port remains functional and the OVRTEMP bit is set to O. This bit remains set until it is read. If the device is still in thermal shutdown when the bit is read, it remains set to 1. Otherwise, the bit is cleared to 0.

#### **Over-Current Shutdown**

If the output current limit of either amplifier is exceeded (see the Electrical Characteristics table), the amplifier in question shuts down for approximately one second. After one second, the amplifier is re-enabled. If the amplifier output current exceeds the limit again, the cycle repeats.

During current-limit shutdown, the  $I^2C$  port remains functional. If the current-limit shutdown was caused by the speaker amplifier, the OVRCURSP bit is set to 1. This bit remains set until it is read. If the speaker amplifier is still in current-limit shutdown when the bit is read, it remains set to 1. Otherwise, the bit is cleared to 0.

#### Signal Path

The input channels have a pre-amplifier stage that can be set from 0dB to 21dB of gain. The headphone amplifiers have separate volume controls that range from -53dB to 6dB. The speaker amplifier has a volume control that ranges from -25dB to 6dB. In addition, the speaker amplifier has a fixed gain of 6dB.

A variety of combinations of these signals can be routed to the headphone amplifiers or the speaker amplifier (*see Table 1*). For example, to connect the left headphone amplifier channel to IN3 and IN1, set the SELHPL3 and SELHPL1 bits to 1. SELHPL4 and SELHPL2 should be set to 0.

The DIFFIN43 and DIFFIN21 bits configure the inputs as differential pairs. When configured as differential, the even-numbered selection bit should be 1 and the oddnumbered selection bit should be 0. For example, if channels 4 and 3 are a differential pair that should be connected to the speaker amplifier, DIFFIN43 and SELSPA4 should be set to 1. SELSPA3, SELSPA2, and SELSPA1 should be set to 0.

Amplifier channels that have no inputs selected should be muted (HPxVOL = 00000 or STARTGAIN = 000000). If an amplifier channel has no input selection bits set to 1, the amplifier channel is turned off. When the speaker amplifier is turned off, the SPKRP and SPKRN outputs stop switching.

Unused audio input pins must be AC grounded.

An integrated Dual-Pole Single-Throw (DPST) analog bypass switch can be used to route system audio signals. For example, baseband audio can be routed to the speaker by connecting the BYPOUTx pins to the SPKRx pins. Baseband audio outputs would then be connected to the BYPINx pins through optional external resistors if the baseband device expects a higher impedance than the existing speaker.

Gain for the headphone amplifier signal path is defined by PGAINxx + HPxVOL.

Gain for the speaker amplifier signal path is defined by PGAINxx + PRESENTGAIN + 6dB.

Internal signal amplitude should not exceed  $2.3V_{PP}$ . Extra caution should be taken when mixing signals. For example, if IN1 is mixed with IN3, the maximum peak to peak amplitude of IN1 plus the maximum peak to peak amplitude of IN3 should not exceed  $2.3V_{PP}$ .

DIFFIN43	DIFFIN21	SELxxx4	SELxxx3	SELxxx2	SELxxx1	xxx Amplifier Input
Х	Х	0	0	0	0	xxx Amplifier Channel Off
0	0	0	0	0	1	IN1
0	0	0	0	1	0	IN2
0	0	0	0	1	1	IN2 + IN1
0	0	0	1	0	0	IN3
0	0	0	1	0	1	IN3 + IN1
0	0	0	1	1	0	IN3 + IN2
0	0	0	1	1	1	IN3 + IN2 + IN1
0	0	1	0	0	0	IN4
0	0	1	0	0	1	IN4 + IN1
0	0	1	0	1	0	IN4 + IN2
0	0	1	0	1	1	IN4 + IN2 + IN1
0	0	1	1	0	0	IN4 + IN3
0	0	1	1	0	1	IN4 + IN3 + IN1
0	0	1	1	1	0	IN4 + IN3 + IN2
0	0	1	1	1	1	IN4 + IN3 + IN2 + IN1
0	1	0	0	0	0	xxx Amplifier Channel Off
0	1	0	0	0	1	Not Supported
0	1	0	0	1	0	IN2 - IN1
	-		-		-	
0	1	0	0	1	1	Not Supported
0	1	0	1	0	0	IN3
0	1	0	1	0	1	Not Supported
0	1	0	1	1	0	IN3 + (IN2 - IN1)
0	1	0	1	1	1	Not Supported
0	1	1	0	0	0	IN4
0	1	1	0	0	1	Not Supported
0	1	1	0	1	0	IN4 + (IN2 - IN1)
0	1	1	0	1	1	Not Supported
0	1	1	1	0	0	IN4 + IN3
0	1	1	1	0	1	Not Supported
0	1	1	1	1	0	IN4 + IN3 + (IN2 - IN1)
0	1	1	1	1	1	Not Supported
1	0	0	0	0	0	xxx Amplifier Channel Off
1	0	0	0	0	1	IN1
1	0	0	0	1	0	IN2
1	0	0	0	1	1	IN2 + IN1
1	0	0	1	0	0	Not Supported
1	0	0	1	0	1	Not Supported
1	0	0	1	1	0	Not Supported
1	0	0	1	1	1	Not Supported
1	0	1	0	0	0	IN4 - IN3
1	0		0	-	÷	(IN4 - IN3) + IN1
		1	-	0	1	
1	0	1	0	1	0	(IN4 - IN3) + IN2
1	0	1	0	1	1	(IN4 - IN3) + IN2 + IN1
1	0	1	1	0	0	Not Supported
1	0	1	1	0	1	Not Supported
1	0	1	1	1	0	Not Supported
1	0	1	1	1	1	Not Supported
1	1	0	0	0	0	xxx Amplifier Channel Off
1	1	0	0	0	1	Not Supported
1	1	0	0	1	0	IN2 - IN1
1	1	0	0	1	1	Not Supported
1	1	0	1	0	0	Not Supported
1	1	0	1	0	1	Not Supported
1	1	0	1	1	0	Not Supported
1	1	0	1	1	1	Not Supported
1	1	1	0	0	0	IN4 - IN3
1	1			0		
		1	0		1	Not Supported
1	1	1	0	1	0	(IN4 - IN3) + (IN2 - IN1)
1	1	1	0	1	1	Not Supported
1	1	1	1	0	0	Not Supported
1	1	1	1	0	1	Not Supported
1	1	1	1	1	0	Not Supported
1	1	1	1	1	1	Not Supported

# Class-G Headphone Amplifier with Capacitor Free Outputs

The FAB2200 includes a regulated charge pump that derives  $CPV_{DD}$  and  $CPV_{SS}$  (the headphone amplifier power supplies) from VBATT. When the headphone output amplitude is low, the  $CPV_{DD}$  is 1.3V and  $CPV_{SS}$  is -1.3V. When needed,  $CPV_{DD}$  and  $CPV_{SS}$  dynamically increase to 1.8V and -1.8V, respectively, to allow for higher output amplitudes. The combination of an efficient regulated charge pump and class-G operation allows low headphone amplifier power dissipation, resulting in longer battery run time.

The negative  $CPV_{SS}$  rail allows the headphone amplifier output to be centered at 0V and eliminates the need for output DC blocking capacitors.

The FAB2200 headphone outputs can be placed in High-Impedance Mode by setting the HIZx bits to 1 (see *Table 2*). This can be useful if the system's headphone jack is shared with other devices. For proper high-

impedance operation, the device must not be in Shutdown Mode. Voltages on HPL and HPR must not exceed  $\pm 1.8V$ .

# Table 2.Headphone Amplifier OutputImpedance, HIZx=1

Output Impedance (Ω)	Frequency (KHz)
11800	40
760	6000
470	13000

# Headphone Volume Control Ramp and Zero-Crossing Detection

The HPRAMP, HPRAMPSPEED, and HPZCD bits control the headphone amplifiers' volume controls when  $HPxV_{OL}$  is changed.

#### Table 3. Headphone Volume Change Behavior

HPRAMP	HPZCD	Behavior When HPxVOL Changes		
0	0	Volume changes immediately.		
0	1	For each channel, wait until a zero crossing occurs in the input before changing volume. If a zero crossing does not occur within HPRAMPSPEED, volume is forced to the new setting.		
1	0	Volume is ramped to the new setting at a rate of HPRAMPSPEED per step.		
1	1	Volume is changed by one step when a zero crossing occurs. If a zero crossing does not occur within HPRAMPSPEED, a step is forced. Only the first zero crossing within HPRAMPSPEED triggers a volume change – volume does not change again until the next HPRAMPSPEED.		

#### Table 4. Headphone Volume Change Timing

HPRAMPSPEED[1:0]	Ramp and ZCD Time Between Steps (ms)
00	0.25
01	2.00
10	16.00
11	128.00

# Programmable Headphone Amplifier Noise Gate

The headphone noise gate automatically mutes the headphone amplifier when its input amplitudes are low to reduce noise during inactivity. This function is not recommended for music playback, but is effective for speech. The amplitude is measured after input preamplifiers and before the headphone amplifier volume controls. The headphone noise gate threshold level is set by the HPNGTHRESH register. The amplitudes of both channels must be less than the noise gate threshold for a time determined by the HPNGTIME register. When the noise gate mutes the amplifier, the HPNGTRIP bit is set to 1.

If either channel's input amplitude goes above the headphone noise gate threshold, both amplifiers are unmuted and the HPNGTRIP bit is set to 0. The amplifiers are returned to the former HPxVOL values.

If either channel is in High-Impedance Mode (HIZx=1), all inputs to that headphone should be deselected (SELHPxx=0) so the noise gate ignores the HIZ channel.

If the HPNGZRA bit is set to 0, the headphone noise gate attack (mute) function occurs immediately rather than waiting for zero-crossing detection or ramping. If the HPNGZRA bit is set to 1, the headphone noise gate attack function obeys headphone zero-crossing detection and ramp settings.

If the HPNGZRR bit is set to 0, the headphone noise gate release (un-mute) function occurs immediately rather than waiting for zero-crossing detection or ramping. If the HPNGZRR bit is set to 1, the headphone noise gate release (un-mute) function obeys headphone zero crossing detection and ramp settings.

# Table 5. Headphone Noise Gate Threshold Voltage

<u> </u>			
HPNGTHRESH [2:0]	Noise Gate Threshold (mV <sub>pk</sub> )		
000	Headphone Noise Gate Disabled		
001	2.8		
010	5.7		
011	11.3		
100	22.6		
101	45.3		
110	90.5		
111	181.0		

#### Table 7. Headphone Noise Gate Timing

HPNGTIME [2:0]	Time (ms)
000	10
001	20
010	40
011	80
100	160

HPNGTIME [2:0]	Time (ms)
101	320
110	640
111	Reserved

Certain combinations of HPRAMP, HPZCD, HPNGZRA, and HPNGZRR are valid as shown in Table 8. Combinations not listed may produce unpredictable results (X = don't care).

Table 8.	Valid Headphone Amplifier Ramp /
Zero Cro	ssing / Noise Gate Combinations

HPRAMP	HPZCD	HPNGZRA	HPNGZRR
0	0	Х	Х
Х	Х	1	1
1	Х	1	0

#### **Class-D Speaker Amplifier**

The class-D amplifier achieves greater than 90% efficiency.

Programmable spread spectrum and edge rate control minimize electromagnetic interference (EMI). Rise and fall times are limited to 20ns per transition at all power levels.

# Programmable Automatic Gain Control (AGC)

The speaker amplifier's AGC can be used to limit output amplitude and reduce clipping as supply voltage varies. The AGC allows high-volume settings while minimizing distortion and protecting the speaker element.

AGC works by comparing the threshold voltage against a proposed output amplitude (the signal's amplitude after all gain stages, before the PWM modulator). If the threshold is exceeded, gain is dynamically reduced until the output voltage level no longer exceeds the threshold or the minimum gain setting. When the output voltage level no longer exceeds the threshold, gain is slowly increased until either the output voltage level exceeds the threshold again or the starting gain is reached.

AGC settings should not be changed while the speaker amplifier is on. Before making changes to THMAX, THVBATT, AGCATTACK, AGCRELEASE, or AGCMIN; the speaker amplifier should be turned off by clearing all SELSPAn bits to 0 or clearing SHDNB to 0.

#### AGC Threshold

The AGC threshold can be thought of as a target for the maximum output amplitude. It is defined by the THMAX and THVBATT registers.

THMAX defines the maximum threshold value regardless of V<sub>BATT</sub> supply voltage. This is useful for protecting speakers from high amplitudes. Table 9 shows the THMAX threshold settings as well as the corresponding maximum RMS power (assuming a 1KHz sine wave into an  $8\Omega$  load).

THMAX [3:0]	Maximum Output Threshold (V <sub>pk</sub> )	Maximum Power with Sine Wave and 8Ω Load (mW)	THMAX [3:0]	Maximum Output Threshold (V <sub>pk</sub> )	Maximum Power with Sine Wave and 8Ω Load (mW)
0000	THMAX	Threshold Disabled	1000	3.6	810.0
0001	2.2	302.5	1001	3.8	902.5
0010	2.4	360.0	1010	4.0	1000.0
0011	2.6	422.5	1011	4.2	1102.5
0100	2.8	490.0	1100	4.4	1210.0
0101	3.0	562.5	1101	4.6	1322.5
0110	3.2	640.0	1110	4.8	1440.0
0111	3.4	722.5	1111	5.0	1562.5

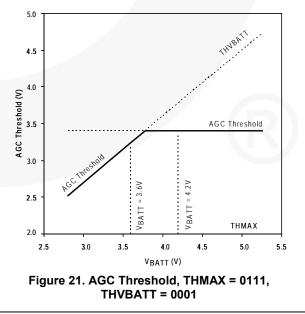
THVBATT limits the amount of clipping allowed by the AGC. As  $V_{\text{BATT}}$  falls, the maximum output amplitude falls. THVBATT defines the threshold as a fraction of the  $V_{\text{BATT}}$  supply voltage. When the fraction is less than 1,

the AGC attempts to adjust gain to prevent clipping. For values greater than 1, some clipping is allowed before the AGC reduces gain (see *Table 10*).

#### Table 10. THVBATT Threshold

THVBATT [4:0]	V <sub>BATT</sub> Fraction (V/V)	THD with 1KHz Sine Wave (%) (V <sub>BATT</sub> =3.7V, 8Ω Load)	THVBATT [4:0]	V <sub>BATT</sub> Fraction (V/V)	THD with 1KHz Sine Wave (%) (V <sub>BATT</sub> =3.7V, 8Ω Load)
0000	THVBATT Thre	eshold Disabled	1000	1.25	13.0
0001	0.90	1.0	1001	1.30	14.4
0010	0.95	3.0	1010	1.35	15.6
0011	1.00	4.9	1011	1.40	16.7
0100	1.05	6.7	1100	1.45	17.7
0101	1.10	8.5	1101	1.50	18.7
0110	1.15	10.0	1110	1.55	19.6
0111	1.20	11.6	1111	1.60	20.5

Ultimately, the AGC threshold is whichever voltage is lower between THVBATT and THMAX. For example, if THMAX = 0111, THVBATT = 0001, and V<sub>BATT</sub> = 4.2V, the AGC threshold is 3.4V as defined by THMAX. If V<sub>BATT</sub> falls to 3.6V, the AGC threshold falls to 3.24V as defined by THVBATT (see Figure 21). If THVBATT and THMAX are both set to 0, the AGC is disabled.



#### Starting Gain

Starting gain is the amount of speaker gain applied when the AGC is not active. It can also be thought of as maximum gain when the AGC is active. Starting gain is controlled by the STARTGAIN register (see Table 11).

Gain Register [5:0]	Gain (dB)	Gain Register [5:0]	Gain (dB
000000	Mute	100000	-9.5
000001	-25.0	100001	-9.0
000010	-24.5	100010	-8.5
000011	-24.0	100011	-8.0
000100	-23.5	100100	-7.5
000101	-23.0	100101	-7.0
000110	-22.5	100110	-6.5
000111	-22.0	100111	-6.0
001000	-21.5	101000	-5.5
001001	-21.0	101001	-5.0
001010	-20.5	101010	-4.5
001011	-20.0	101011	-4.0
001100	-19.5	101100	-3.5
001101	-19.0	101101	-3.0
001110	-18.5	101110	-2.5
001111	-18.0	101111	-2.0
010000	-17.5	110000	-1.5
010001	-17.0	110001	-1.0
010010	-16.5	110010	-0.5
010011	-16.0	110011	0
010100	-15.5	110100	0.5
010101	-15.0	110101	1.0
010110	-14.5	110110	1.5
010111	-14.0	110111	2.0
011000	-13.5	111000	2.5
011001	-13.0	111001	3.0
011010	-12.5	111010	3.5
011011	-12.0	111011	4.0
011100	-11.5	111100	4.5
011101	-11.0	111101	5.0
011110	-10.5	111110	5.5
011111	-10.0	111111	6.0

## Table 11.Speaker Gain Values

#### AGC Attack

AGC attack occurs when the AGC determines that, after applying present gain, the output signal amplitude would be too high and gain should be stepped down by 1dB. The AGC checks an approximation of the amplitude of the output signal that includes present gain, but excludes clipping that may occur in the final output stage. All of the following conditions must be true to trigger an AGC attack:

- The amplitude is above the AGC threshold, AND
- Present gain is above the minimum gain point, AND
- Attack speed is not exceeded.

The minimum gain is determined by the AGCMIN register. The rate of gain reduction is determined by the AGCATTACK register.

#### AGC Release

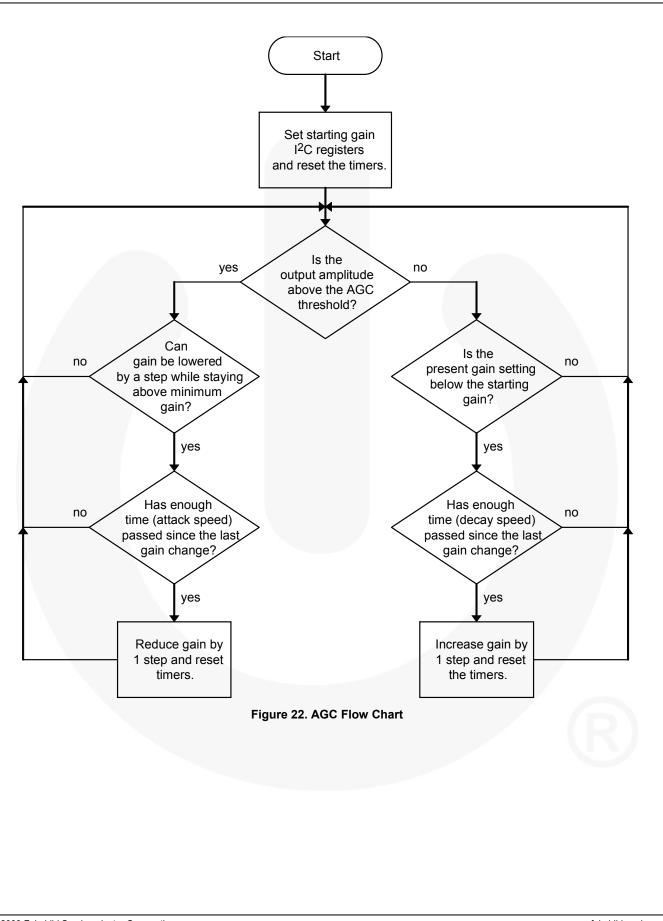
When the output signal is below the AGC threshold, gain is stepped up by 1dB. The rate of gain increase is determined by the AGCRELEASE registers. Gain is increased until it reaches the starting gain or an AGC attack is triggered again.

AGCATTACK [2:0]	AGC Attack Speed (µs/Step)	AGCATTACK [2:0]	AGC Attack Speed (µs/Step
000	12.5	100	200
001	25.0	101	400
010	50.0	110	800
011	100.0	111	1600

#### Table 12. AGC Attack Speed

#### Table 13. AGC Release Speed

AGCRELEASE [2:0]	AGC Release Speed (ms/Step)	AGCRELEASE [2:0]	AGC Release Speed (ms/Step)	
000	12.5	100	200	
001	25.0	101	400	
010	50.0	110	800	
011	100.0	111	1600	



FAB2200 — Audio Subsystem with Stereo Class-G Headphone Amplifier

# FAB2200 — Audio Subsystem with Stereo Class-G Headphone Amplifier

## Programmable Speaker Amplifier Noise Gate

The speaker noise gate automatically mutes the speaker amplifier when its input amplitude is low to reduce noise during inactivity. This function is not recommended for music playback, but is effective for speech. The amplitude is measured after input pre-amplifiers, but before the speaker amplifier's volume control. The speaker noise gate's threshold level is set by the SPNGTHRESH register. The amplitude must be less than the speaker noise gate threshold for a time determined by the SPNGTIME register. When the speaker noise gate mutes the speaker amplifier, the SPNGTRIP bit is set to 1.

If the input amplitude goes above the speaker noise gate threshold, the speaker amplifier is un-muted and the SPNGTRIP bit is set to 0. If the AGC is not enabled, the speaker amplifier is returned to its former PRESENTGAIN value. If the AGC is enabled, AGCRELEASE speed determines the new PRESENTGAIN value.

SPNGTHRESH [2:0]	Speaker Noise Gate Threshold (mVpk)		
000	Speaker Noise Gate Disabled		
001	2.8		
010	5.7		
011	11.3		
100	22.6		
101	45.3		
110	90.5		
111	181.0		

#### Table 14. Speaker Noise Gate Threshold Voltage

#### Table 15. Speaker Noise Gate Timing

SPNGTIME [2:0]	Time (ms)
000	10
001	20
010	40
011	80
100	160
101	320
110	640
111	Reserved

## Speaker Amplifier Gain Ramp and Zero-Crossing Detection (ZCD)

The SPRAMP, SPRAMPSPEED, and SPZCD bits control the speed at which PRESENTGAIN is changed when STARTGAIN is changed.

SPRAMP	SPZCD	Behavior When STARTGAIN Is Changed
0	0	STARTGAIN changes immediately.
0	1	Wait until a zero crossing occurs in the input before changing STARTGAIN. If a zero crossing does not occur within SPRAMPSPEED, STARTGAIN is forced to the new setting.
1	0	STARTGAIN is ramped to the new setting at a rate of SPRAMPSPEED per step.
1	1	STARTGAIN is changed by one step when a zero crossing occurs. If a zero crossing does not occur within SPRAMPSPEED, a step is forced. Only the first zero crossing within SPRAMPSPEED triggers a gain change – gain does not change again until the next SPRAMPSPEED.

#### Table 16. Speaker Gain Change Behavior

#### Table 17. Speaker Gain Change Timing

SPRAMPSPEED[1:0]	Ramp and ZCD Time Between Steps (ms)
00	0.25
01	2.00
10	16.00
11	128.00

SPRAMP, SPRAMPSPEED, and SPZCD have no effect on AGC and noise gate timing. AGC and noise gate timing have no effect on speaker amplifier gain ramp and zero-crossing detection. In the event of a conflict between these systems, PRESENTGAIN chooses the lowest gain setting. For example, SPRAMP is enabled with a slow SPRAMPSPEED and a fast AGCATTACK. The user changes STARTGAIN from 111111 to 000001. As the ramp function begins to ramp PRESENTGAIN down slowly (as defined by SPRAMPSPEED), a loud sound surpasses the AGC threshold. This forces PRESENTGAIN to react quickly (as defined by AGCATTACK). If the sound's amplitude falls below the AGC threshold before PRESENTGAIN reaches 000001, the quick gain reduction halts and the slow gain reduction resumes.

Valid combinations of SPRAMP, SPZCD, SPNGZRA, and SPNGZRR are shown in Table 18. Combinations not listed may produce unpredictable results.

Table 18.	Valid Speaker	· Amplifier Ramp	/ Zero Crossing	/ Noise Gate Combinations
-----------	---------------	------------------	-----------------	---------------------------

SPRAMP	SPZCD	SPNGZRA	SPNGZRR	
0	0	X	X	
X	Х	1	1	
1	Х	1	0	

#### Note:

6. X = don't care.

If the SPNGZRA bit is set to 0, the speaker noise gate attack (mute) function occurs immediately rather than waiting for zero-crossing detection or ramping. If the SPNGZRA bit is set to 1, the speaker noise gate attack function obeys speaker zero crossing detection and ramp settings. If the SPNGZRR bit is set to 0, the speaker noise gate release (un-mute) function occurs immediately rather than waiting for zero-crossing detection or ramping. If the SPNGZRR bit is set to 1, the speaker noise gate release (un-mute) function obeys speaker zero-crossing detection and ramp settings.

П

# I<sup>2</sup>C Control

Writing to and reading from the FAB2200 registers is accomplished via the  $I^2C$  interface. The  $I^2C$  protocol requires that one device on the bus initiates and controls all read and write operations. This device is called the "master" device. The master device also generates the SCL signal, which is the clock signal for all other devices on the bus, called "slave" devices. The FAB2200 is a slave device. Both the master and slave devices can send and receive data on the bus.

During  $I^2C$  operations, one data bit is transmitted per clock cycle. All  $I^2C$  operations follow a repeating nineclock-cycle pattern that consists of eight bits (one byte) of transmitted data followed by an acknowledge (ACK) or not acknowledge (NACK) from the receiving device. Note that there are no unused clock cycles during any operation – therefore, there must be no breaks in the stream of data and ACKs/NACKs during data transfers.

For most operations, I<sup>2</sup>C protocol requires the SDA line to remain stable (unmoving) whenever SCL is HIGH;i.e., transitions on the SDA line can only occur when SCL is LOW. The exceptions to this rule are when the master device issues a START or STOP condition. A slave device cannot issue a START or STOP condition.

**START Condition:** This condition occurs when the SDA line transitions from HIGH to LOW while SCL is HIGH. The master device uses this condition to indicate that a data transfer is about to begin.

**STOP Condition:** This condition occurs when the SDA line transitions from LOW to HIGH while SCL is HIGH. The master device uses this condition to signal the end of a data transfer.

Acknowledge and Not Acknowledge: When data is transferred to the slave device, it sends an acknowledge (ACK) after receiving every byte of data. The receiving (slave) device sends an ACK by pulling SDA LOW for one clock cycle.

When the master device is reading data from the slave device, the master sends an ACK after receiving every byte of data. Following the last byte, a master device sends a "not acknowledge" (NACK) instead of an ACK, followed by a STOP condition. A NACK is indicated by leaving SDA HIGH during the clock after the last byte.

#### **Slave Address**

Each slave device on the bus has a unique address so the master can identify which device is sending or receiving data. The FAB2200 slave address is 1001101X binary where "X" is the read/write bit. Master write operations are indicated when X=0. Master read operations are indicated when X=1.

# Writing to and Reading from the FAB2200

All read and write operations must begin with a START condition generated by the master device. After the START condition, the master device must immediately send a slave address (7 bits), followed by a read/write bit. If the slave address matches the address of the FAB2200, the FAB2200 sends an ACK by pulling the SDA line LOW for one clock cycle.

## Setting the Pointer

For all operations, the pointer stored in the command register must be pointing to the register that is going to be written to or read from. To change the pointer value in the Command register, the read/write bit following the address must be 0. This indicates that the master writes new information into the Command register.

After the FAB2200 sends an ACK in response to receiving the address and read/write bit, the master device must transmit an appropriate 8-bit pointer value, as explained in the  $I^2C$  Registers section. The FAB2200 sends an ACK after receiving the new pointer data.

The pointer set operation is illustrated in Figure 25 and Figure 26. Any time a pointer set is performed, it must be immediately followed by a read or write operation. The Command register retains the current pointer value between operations; therefore subsequent read operations do not require a pointer set cycle. Write operations always require the pointer be reset.

#### Reading

If the pointer is already pointing to the desired register, the master can read from that register by setting the read/write bit (following the slave address) to 1. After sending an ACK, FAB2200 begins transmitting data during the following clock cycle. The master should respond with a NACK, followed by a STOP condition (see Figure 23).

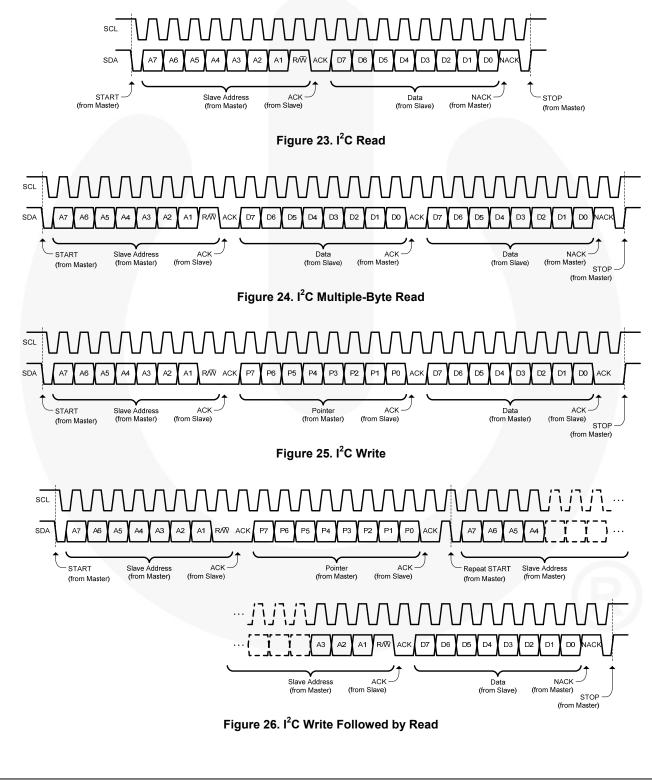
The master reads multiple bytes by responding to the data with an ACK instead of a NACK and continuing to send SCL pulses, as shown in Figure 24. The FAB2200 increments the pointer by one and sends the data from the next register. The master indicates the last data byte by responding with a NACK, followed by a STOP.

To read from a register other than the one currently indicated by the Command register, a pointer to the desired register must be set. Immediately following the pointer set, the master must perform a REPEAT START condition (*see Figure 26*), which indicates to the FAB2200 that a new operation is about to occur. If the REPEAT START condition does not occur, the FAB2200 assumes that a write is taking place and the selected register is overwritten by the upcoming data on the data bus. After the START condition, the master must again send the device address and read/write bit. This time, the read/write bit must be set to 1 to indicate a read. The rest of the read cycle is the same as described in the previous paragraphs for reading from a preset pointer location.

## Writing

All writes must be preceded by a pointer set, even if the pointer is already pointing to the desired register. Immediately following the pointer set, the master must begin transmitting the data to be written. After transmitting each byte of data, the master must release the Serial Data (SDA) line for one clock cycle to allow the FAB2200 to acknowledge receiving the byte. The write operation should be terminated by a STOP condition from the master (see Figure 25).

As with reading, the master can write multiple bytes by continuing to send data. The FAB2200 increments the pointer by 1 and accepts data for the next register. The master indicates the last data byte by issuing a STOP.



П

# **Register Map**

The  $I^2C$  slave address is 1001101x, where x=0 for write operations and x=1 for read operations.

Address	B7	B6	B5	B4	B3		B2	B1	В0
0x00		VERSION		SPNGT	RIP	OVRTEMP	OVRCURSP	0	
0x01	HIZL	HIZR	0	BYPEN 0			0	0	SHDNB
0x02	DIFFIN43	DIFFIN21	PGAIN43					PGAIN21	
0x03	SELSPA4	SELSPA3	SELSPA2	SELSPA1	Н	PRA	MPSPEED	HPZCD	HPRAMP
0x04	SELHPL4	SELHPL3	SELHPL2	SELHPL1	SELHP	R4	SELHPR3	SELHPR2	SELHPR1
0x05	0	0	HPLVOL				L		0
0x06	0	0		HPRVOL				0	
0x07	HPNGZR A	F	IPNGTHRE	PNGTHRESH HPNG2			н	IPNGTIME	
0x08	ERC	0	0	0	S	PRA	MPSPEED	SPZCD	SPRAMP
0x09	SPNGZRA	S	PNGTHRE	ESH	SPNGZ	RR	S		
0x0A		TH	MAX				THVBA	λTT	
0x0B	0		AGCATTA	СК	0		AG	CRELEASE	
0x0C	0	0				A	AGCMIN		
0x0D	0	0				PRE	SENTGAIN		
0x0E	0	0				ST	ARTGAIN		
0x0F	0	0		MCSSMT				SSMT	

Bits labeled "0" have no effect if written. When read, the value is always 0.

Bits and addresses not listed in the register map are for testing only. These bits should never be written. When read, they may return any value.

# **Register Descriptions**

Address	B7	B6	B5	B4	B3	B2	B1	B0
0x00		VERSION		HPNGTRIP	SPNGTRIP	OVRTEMP	OVRCURSP	0
default		010		0	0	0	0	0

#### VERSION (Read only)

Indicates the silicon revision number.

#### HPNGTRIP (Read only)

1 = Headphone amplifiers are being muted by the noise gate.

0 = Normal operation.

#### SPNGTRIP (Read only)

1 = Speaker amplifier is being muted by the noise gate.

0 = Normal operation.

#### **OVRTEMP** (Read/Clear)

1 = The junction temperature of the device has exceeded the thermal shutdown threshold. (This bit remains set until it is read.)

0 = Normal operation.

#### OVRCURSP (Read/Clear)

1 = The output current limit of the speaker amplifier has been exceeded. (This bit remains set until it is read.)

0 = Normal operation.

Address	B7	B6	B5	B4	B3	B2	B1	В0
0x01	HIZL	HIZR	0	BYPEN	0	0	0	SHDNB
default	0	0	0	0	0	0	0	0

#### HIZx

1 = HPx is muted and output is in High-Impedance Mode (see Table 2).

0 = Normal operation.

#### BYPEN

1 = DPST analog bypass switch is closed.

0 = DPST analog bypass switch is open.

#### SHDNB

1 = Normal operation.

0 = Low-power Shutdown Mode.

Address	B7	B6	B5	B4	B3	B2	B1	В0
0x02	DIFFIN43	DIFFIN21	PGAIN43				PGAIN21	
default	0	0	0	0	0	0	0	0

#### DIFFIN43

1 = IN4 and IN3 are configured as a differential pair.

0 = IN4 and IN3 are independent.

#### DIFFIN21

1 = IN2 and IN1 are configured as a differential pair.

0 = IN2 and IN1 are independent.

#### PGAIN43

PGAIN43 sets the pre-amplifier gain for IN4 and IN3.

#### PGAIN21

PGAIN21 sets the pre-amplifier gain for IN2 and IN1.

PGAINxx [2:0]	Pre-Amplifier Gain (dB)	PGAINxx [2:0]	Pre-Amplifier Gain (dB)
000	0	100	12
001	3	101	15
010	6	110	18
011	9	111	21

Address	B7	B6	B5	B4	B3	B2	B1	В0
0x03	SELSPA4	SELSPA3	SELSPA2	SELSPA1	HPRAM	PSPEED	HPZCD	HPRAMP
default	0	0	0	0	0	0	0	0
0x04	SELHPL4	SELHPL3	SELHPL2	SELHPL1	SELHPR4	SELHPR3	SELHPR2	SELHPR1
default	0	0	0	0	0	0	0	0

#### SELSPAx

1 = Channel INx is added to the speaker amplifier's input.

0 = Channel INx is disconnected from the speaker amplifier's input.

If all four SELSPAx bits are 0, the speaker amplifier is turned off and the SPKRP and SPKRN outputs stop switching.

#### SELHPLx

1 = Channel INx is added to the left headphone amplifier's input.

0 = Channel INx is disconnected from left headphone amplifier's input.

If all four SELHPLx bits are 0, the left headphone amplifier is turned off.

#### SELHPRx

1 = Channel INx is added to the right headphone amplifier's input.

0 = Channel INx is disconnected from right headphone amplifier's input.

If all four SELHPRx bits are 0, the right headphone amplifier is turned off.

#### HPRAMPSPEED

HPRAMPSPEED sets timing for the headphone amplifiers' ramp function according to Table 4.

#### HPZCD

1 = Headphone amplifier zero-crossing detection is enabled.

0 = Headphone amplifier zero-crossing detection is disabled.

#### HPRAMP

- 1 = Headphone amplifier volume ramping is enabled.
- 0 = Headphone amplifier volume ramping is disabled.

Address	B7	B6	B5	B4	B3	B2	B1	В0			
0x05	0	0		HPLVOL							
default	0	0	0	0	0	0	0	0			
0x06	0	0		HPRVOL							
default	0	0	0	0	0	0	0	0			

#### HPxVOL

HPxVOL sets the gain of the headphone amplifiers according to Table 19.

HPxVOL does not include PGAINxx. Gain for the entire headphone amplifier signal path is defined by PGAINxx + HPxVOL.

#### Table 19. Headphone Amplifier Gain Settings

HPxVOL [4:0]	Gain (dB)	HPxVOL [4:0]	Gain (dB)		
00000	mute	10000	-9		
00001	-53	10001	-8		
00010	-49	10010	-7		
00011	-45	10011	-6		
00100	-41	10100	-5		
00101	-37	10101	-4		
00110	-33	10110	-3		
00111	-29	10111	-2		
01000	-25	11000	-1		
01001	-23	11001	0		
01010	-21	11010	1		
01011	-19	11011	2		
01100	-17	11100	3		
01101	-15	11101	4		
01110	-13	11110	5		
01111	-11	11111	6		

Address	B7	B6	B5	B4	В3	B2	B1	В0
0x07	HPNGZRA	HPNGTHRESH			HPNGZRR	HPNGTIME		
default	0	0	0	0	0	0	0	0

#### HPNGZRA

1 = The headphone noise gate attack function obeys headphone zero-crossing detection and ramp settings.

0 = The headphone noise gate attack (mute) function occurs immediately rather than waiting for zero-crossing detection or ramping.

#### HPNGTHRESH

HPNGTHRESH sets the threshold voltage for the headphone amplifiers' noise gate function according to Table 1.

#### HPNGZRR

1 = The headphone noise gate release (un-mute) function obeys headphone zero-crossing detection and ramp settings.

0 = The headphone noise gate release (un-mute) function occurs immediately rather than waiting for zero-crossing detection or ramping.

#### HPNGTIME

HPNGTIME sets the timing for the headphone amplifiers' noise gate function according to Table 6.

Address	B7	B6	B5	B4	B3	B2	B1	B0
0x08	ERC	0	0	0	SPRAMPSPEED		SPZCD	SPRAMP
default	0	0	0	0	0	0	0	0

#### ERC

1 = Speaker amplifier edge-rate control is enabled.

0 = Speaker amplifier edge-rate control is disabled.

#### SPRAMPSPEED

SPRAMPSPEED sets timing for the speaker amplifier's ramp function according to Table 17.

#### SPZCD

1 = Speaker amplifier zero-crossing detection is enabled.

0 = Speaker amplifier zero-crossing detection is disabled.

#### SPRAMP

1 = Speaker amplifier gain ramping is enabled.

0 = Speaker amplifier gain ramping is disabled.

Address	B7	B6	B5	B4	B3	B2	B1	B0
0x09	SPNGZRA	SPNGTHRESH			SPNGZRR	SPNGZRR SPNGTIME		
default	0	0	0	0	0	0	0	0

#### SPNGZRA

1 = The speaker noise gate attack function obeys speaker zero-crossing detection and ramp settings.

0 = The speaker noise gate attack (mute) function occurs immediately rather than waiting for zero-crossing detection or ramping.

#### SPNGTHRESH

SPNGTHRESH sets the threshold voltage for the speaker amplifier's noise gate function according to Table 14.

#### SPNGZRR

1 = The speaker noise gate release (un-mute) function obeys speaker zero-crossing detection and ramp settings.

0 = The speaker noise gate release (un-mute) function occurs immediately rather than waiting for zero-crossing detection or ramping.

#### SPNGTIME

SPNGTIME sets the timing for the speaker amplifier's noise gate function according to Table 15.

Address	B7	B6	B5	B4	B3	B2	B1	В0
0x0A		THM	ЛАХ		THVBATT			
default	0 0 0 0				0	0	0	0

#### THMAX

THMAX sets the maximum threshold voltage for the speaker amplifier's AGC according to Table 9.

#### THVBATT

THVBATT sets the clipping level relative to V<sub>BATT</sub> for the speaker amplifier's AGC according to Table 10.

FAB2200
- Audio S
Subsystem
Audio Subsystem with Stereo Class-G H
e Class-G
Headphone A
ne Amplifier

Address	B7	B6	B5	B4	B3	B2	B1	В0
0x0B	0	AGCATTACK			0	A	GCRELEAS	E
default	0	0 0 0			0	0	0	0

#### AGCATTACK

AGCATTACK sets the attack speed for the speaker amplifier's AGC according to Table 12.

#### AGCRELEASE

AGCRELEASE sets the release speed for the speaker amplifier's AGC according to Table 13.

Address	B7	B6	B5	B4	B3	B2	B1	B0	
0x0C	0	0	AGCMIN						
default	0	0	0	0	0	0	0	0	

#### AGCMIN

AGCMIN sets the minimum gain for the speaker amplifier's AGC according to Table 11.

Address	B7	B6	B5	B4	B3	B2	B1	B0
0x0D	0	0	PRESENTGAIN					

#### PRESENTGAIN

(Read only)

PRESENTGAIN is the actual gain setting for the speaker amplifier according to Table 11. The target value for PRESENTGAIN is set by STARTGAIN. However, PRESENTGAIN may be changed automatically by the AGC or the noise gate.

PRESENTGAIN does not include PGAINxx. Gain for the entire speaker amplifier signal path is defined by PGAINxx + PRESENTGAIN.

Address	B7	B6	В5	5 E	84	B3		B2	B1	B0	)
0x0E	0	0	STARTGAIN								
default	0	0	0	0	0	(	)	(	0	0	

#### STARTGAIN

STARTGAIN is the volume setting for the speaker amplifier according to Table 11.

Address	B7	B6	B5	B4	B3	B2	B1	B0
0x0F	0	0	MCSSMT			SSMT		
default	0	0	1	0	0	0	0	0

#### SSMT

Sets the spread-spectrum modulation of the class-D amplifier. See Table 20 for the amount of modulation. A setting of 000 results in a ±5.3% modulation in the speaker amplifier's output frequency. A setting of 100 disables spread-spectrum modulation.

SSMT [2:0]	Class-D Spread-Spectrum Modulation Trim (±%)
000	5.3
001	7.0
010	10.6
011	21.2
100	0.0
101	3.0
110	3.6
111	4.2

#### MCSSMT [5:3]

Sets the spread-spectrum modulation of the master clock. See Table 21 for amount of modulation. Modulating the master clock does not modulate the class-D output frequency because the triangle wave generator is PLL controlled.

#### Table 21. Master Clock Spread-Spectrum Modulation Trim

MCSSMT [2:0]	Master Clock Spread-Spectrum Modulation Trim (± %)				
000	5.3				
001	7.0				
010	10.6				
011	21.2				
100	0.0				
101	3.0				
110	3.6				
111	4.2				

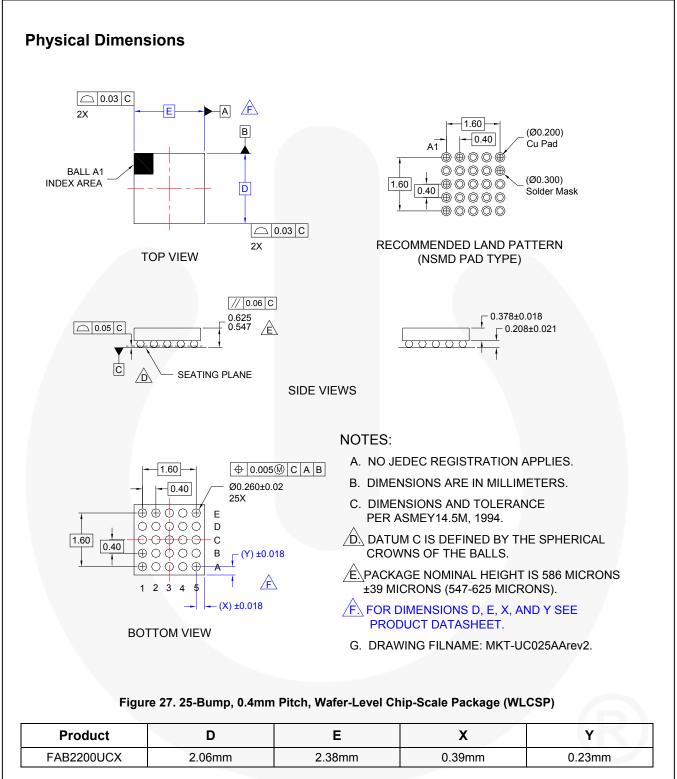
# **Applications Information**

#### **Layout Considerations**

General layout and supply bypassing play a major role in analog performance and thermal characteristics. Fairchild offers a demonstration board to guide layout and aid device evaluation (contact Fairchild for details). Following this layout configuration provides optimum performance for the device. For the best results, follow the steps and recommended routing rules listed below.

#### **Recommended Routing / Layout Rules**

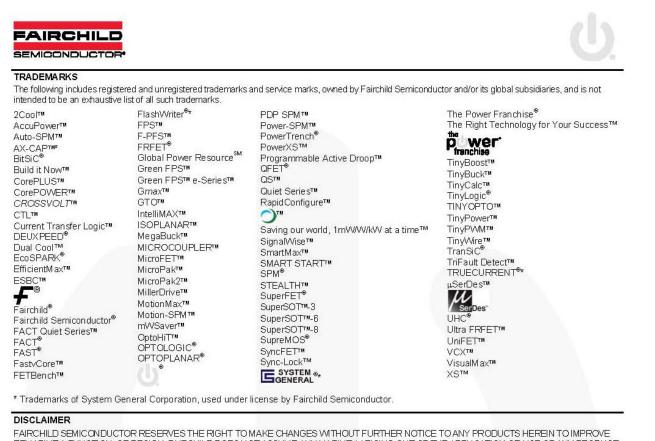
- Do not run analog and digital signals in parallel.
- Use separate analog and digital power planes to supply power.
- Place the speaker amplifier output as close as possible to the speaker element to reduce EMI.
- Traces should be run on top of the ground plane at all times.
- No trace should run over ground / power splits.
- Avoid routing at 90-degree angles.
- Place bypass capacitors within 0.1 inches of the device power pin.
- Minimize all trace lengths to reduce series inductance.



Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent version. Package specifications do not expand Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductors online packaging area for the most recent packaging drawings and tape and reel specifications <u>http://www.fairchildsemi.com/packaging/</u>.

FAB2200 — Audio Subsystem with Stereo Class-G Headphone Amplifier



FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN, NETHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

Datasheet Identification	Product Status	Definition			
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.			
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.			
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.			
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.			

П

AB2200 — Audio Subsystem with

Stereo Class-G Headphone Amplifier